

#2 / Pre-Amend A
4-18-02
Juo

PATENT
Customer No. 22,852
Attorney Docket No. 7447.0021-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
)
Jeng Ping LU et al.) Group Art Unit: Unknown
)
Rule 53(b) Divisional of Prior Application:) Examiner: Unknown
Serial No. 09/419,293, filed 10/15/99)
)
Serial No.: Not Yet Assigned)
)
For: DUAL DIELECTRIC STRUCTURE)
FOR SUPPRESSING LATERAL)
LEAKAGE CURRENT IN HIGH)
FILL FACTOR ARRAYS)

Commissioner for Patents and Trademarks
Washington, DC 20231

Sir:

PRELIMINARY AMENDMENT

Prior to the examination of the above application, please amend this application
as follows:

IN THE CLAIMS:

Please cancel claims 1-6, without prejudice or disclaimer of the subject matter,
and add new claims 11-15, as follows:

11. (New) A high fill factor image array formed by:
providing a plurality of source-drain metal contacts;
depositing a first passivation layer;
depositing a second passivation layer over the first passivation layer that
suppresses lateral leakage current;

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Sub
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